

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
		228/4.5.ccls..ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:30
		L1 or L2 or L3 or L5 or L6 or L7 or L8 or L9 or L10 or L11 or L12 or L13 or L14 or L15 or s`5 or L16 or L17	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
		ceramic.clm. and capillary.clm. and bonding.clm. and (binder same thermoplastic)	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:25
		ceramic.clm. and capillary.clm. and bonding.clm. and (binder same thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:23
		ceramic.clm. and capillary.clm. and (binder same thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:17
		ceramic.clm. and capillary.clm. and bonding.clm. and (binder same thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:25
L1	898	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:28
L2	431	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:28

L3	212	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:28
L4	898	L1 or L2 or L3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:28
L5	73	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L6	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L7	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L8	572	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L9	181	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L10	57	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29

L11	572	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L12	34	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L13	181	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L14	57	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L15	51	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L16	9	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/06/27 01:29
L17	17	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L18	314	264/669.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L19	250	264/670.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29

L20	299	264/614.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L21	104	264/629.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
L22	1404	228/4.5.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:30
S1	898	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:49
S2	431	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:50
S3	212	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:50
S4	73	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:23
S5	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:51

S6	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:51
S7	572	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:51
S8	181	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:28
S9	57	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:57
S10	572	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:57
S11	34	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 21:01
S12	181	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 21:01
S13	57	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 21:01

S14	51	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:06
S15	46	("2892924"   "3538205"   "3660050"   "3986653"   "4020543"   "4171477"   "4182947"   "4315128"   "4331048"   "4387283"   "4390771"   "4502983"   "4513190"   "4691854"   "4705204"   "4897710"   "4909427"   "4998002"   "5178742"   "5180093"   "5214259"   "5217154"   "5280979"   "5290507"   "5367956"   "5463197"   "5463896"   "5491605"   "5527441"   "5544804"   "5601740"   "5616257"   "5649355"   "5651901"   "5676856"   "5797388"   "5816472"   "5827470"   "5931368"   "6030472"   "6073827").PN. OR ("6354479").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/06/25 21:50
S16	9	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/06/25 21:50
S17	10	ceramic.clm. and capillary.clm. and bonding.clm. and binder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:06
S18	17	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:16